969973-3 ✔ ACTIVE

AMPMODU | AMPMODU HV-100/HV-190

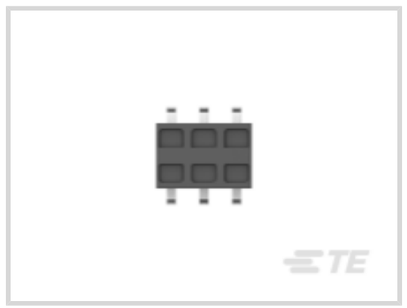
TE Internal #: 969973-3

PCB Mount Receptacle, Vertical, Board-to-Board, 6 Position, 2.54 mm [.1 in] Centerline, Gold, Surface Mount, Signal, Black, AMPMODU HV-100/HV-190

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles







PCB Connector Assembly Type: **PCB Mount Receptacle**

PCB Mount Orientation: **Vertical**

Connector System: **Board-to-Board**

Number of Positions: **6**

Number of Rows: **2**

Features

Product Type Features

PCB Connector Assembly Type	PCB Mount Receptacle
Connector System	Board-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Stackable	Yes
PCB Mount Orientation	Vertical
Number of Positions	6
Number of Rows	2
Board-to-Board Configuration	Parallel

Body Features

Connector Profile	Standard
Primary Product Color	Black

Contact Features

Contact Protection Type	Closed Entry Housing
Mating Square Post Dimension	.64 mm[.025 in]
PCB Contact Termination Area Plating Material Thickness	2.5 µm
Contact Layout	Inline
Mating Pin Diameter	.63 mm[.025 in]
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.762 µm[30 µin]
Contact Type	Socket
Contact Current Rating (Max)	3 A

Termination Features

Rectangular Termination Post & Tail Thickness	.2 mm[.008 in]
Rectangular Termination Post & Tail Width	.7 mm[.027 in]
Termination Method to Printed Circuit Board	Surface Mount

Mechanical Attachment

Mating Alignment	Without
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount

Housing Features

Mating Entry Location	Bottom & Top
Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	LCP (Liquid Crystal Polymer)

Dimensions

Connector Height	6.2 mm[.244 in]
Row-to-Row Spacing	2.54 mm[.1 in]
Stack Height	9 mm[.354 in]
PCB Thickness (Recommended)	1.6 mm[.063 in]

Usage Conditions

Operating Temperature Range	-65 - 125 °C[-85 - 257 °F]

Operation/Application

Solder Process Feature	Board Standoff
Circuit Application	Signal

Industry Standards

UL Flammability Rating	UL 94V-0

Packaging Features

Packaging Quantity	600
Packaging Method	Reel

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2024 (240) Candidate List Declared Against: JAN 2024 (240) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

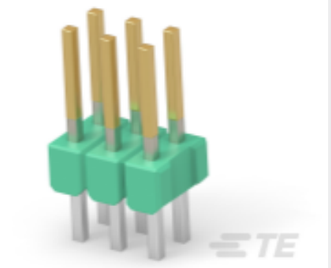
Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



TE Part # 826634-3
AMPMODU MOD II PIN HEADER



TE Part # 826632-3
3P AMPMODU II PIN HDR.



TE Part # 826656-3
3P AMPMODU II STIFT LEI



TE Part # 1241050-3
2x3P MOD II BREAK AWAY HDR,SMD, BLISTER



TE Part # 826662-3
3P AMPMODU II STIFT LEI



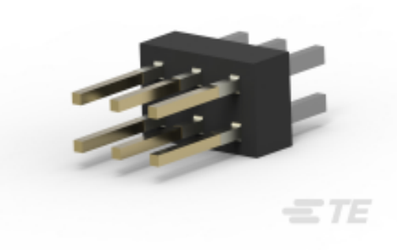
TE Part # 829394-3
2X3P MOD II UNSHRD HDR, ST, 0.8 AU



TE Part # 966709-3
2X3P MODUII BREAK AWAY HEADER, SMD



TE Part # 826658-3
3P AMPMODU II STIFT LEI



TE Part # 215447-3
2X 3P MOD2 STIFTLEI



TE Part # 826664-3
3P MOD2 STIFT LEI

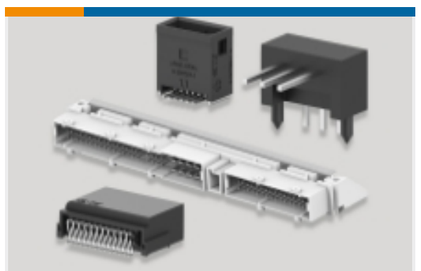


TE Part # 828132-3
3P MOD2 STIFT LEI



TE Part # 966269-3
2x3P MOD II BREAK AWAY HDR,SMD, TUBE PKG

Also in the Series | AMPMODU HV-100/HV-190

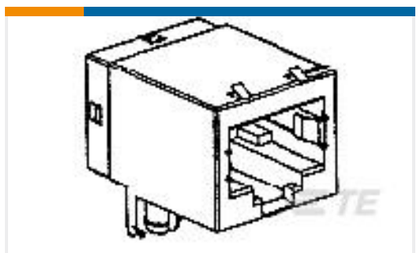


PCB Headers & Receptacles(333)

Customers Also Bought



TE Part # 2-1445053-3
MICRO MNL HDR ASSY S/ROW LF



TE Part # 5558341-1
MJ,8POS,R/A,CAT 5e



TE Part # 2173157-3
MICRO USB, TYPE B, SPLASHPROOF (LOW MOQ)



TE Part # 001-0009
ANTENNA,2.4/5.5 GHz Dipole



TE Part # 225284-E
M12 FEMALE, D CODE,RA, 4P THR REAR MOUNT



TE Part # 225456-E
M12 MALE, A CODE, RA, 5P THR REAR MOUNT



TE Part # 284740-E
M12 MALE, A CODE, 5P, 10.5MM SMT



TE Part # 826467-5
5P MOD II SHROUDED HEADER, ST

TE Part # 225459-E
M12 MALE, A CODE,RA, 5P THR FRONT MOUNT

TE Part # 9-329631-3
JAM NUT

Documents

CAD Files

Customer View Model

ENG_CVM_CVM_969973-3_E.2d_dxf.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_969973-3_E.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_969973-3_E.3d_stp.zip

English

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